TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT   SILICON MONOLITHIC

TD62064P,TD62064AP,TD62064F,TD62064AF
TD62074P,TD62074AP,TD62074F,TD62074AF

4CH HIGH−CURRENT DARLINGTON SINK DRIVER

The TD62064P / AP / F / AF and TD62074P / AP / F / AF are high−voltage, high−current darlington drivers comprised of four NPN darlington pairs.

All units feature integral clamp diodes for switching inductive loads and all units of TD62074P / AP / F / AF feature uncommitted collectors and emitters for isolated darlington applications.

For proper operation, the substrate (SUB) must be connected to the most negative voltage.

Applications include relay, hammer, lamp and stepping moter drivers.

FEATURES

- Output current (single output) 1.5 A (Max)
- High sustaining voltage output
  35 V (Min) (TD62064P / F, 074P / F)
  50 V (Min) (TD62064AP / AF, 074AP / AF)
- Output clamp diodes　　：TD62064P / AP / F / AF
- Isolated darlington array：TD62074P / AP / F / AF
- Input compatible with TTL and 5 V CMOS
- GND and SUB terminal = heat sink
- Package type−P, AP: DIP−16 pin
- Package type−F, AF: HSOP−16 pin

TD62064P
TD62064AP
TD62074P
TD62074AP
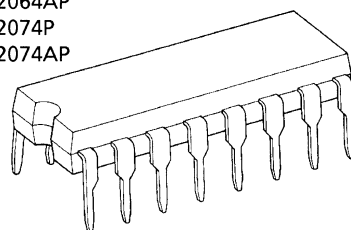
DIP16-P-300-2.54A

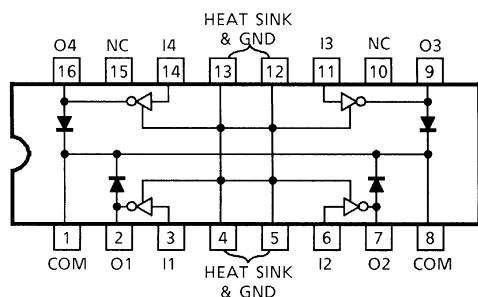TD62064F
TD62064AF
TD62074F
TD62074AF
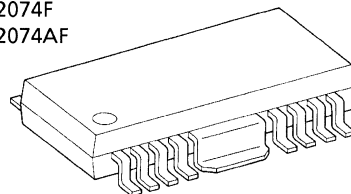
HSOP16-P-300-1.00

Weight
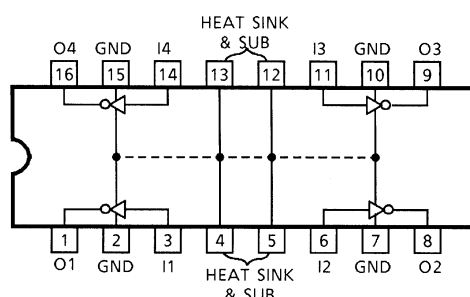DIP16−P−300−2.54A　: 1.11 g (Typ.)
HSOP16−P−300−1.00 : 0.50 g (Typ.)
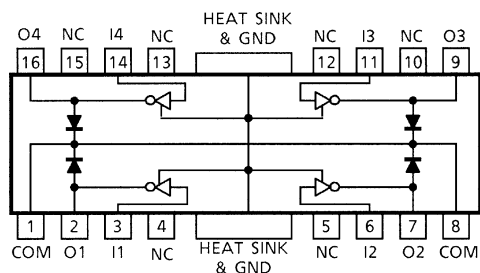
PIN CONNECTION (TOP VIEW)

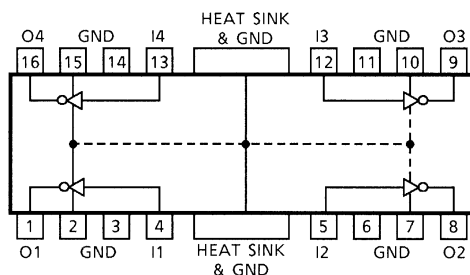#### TD62064P / AP

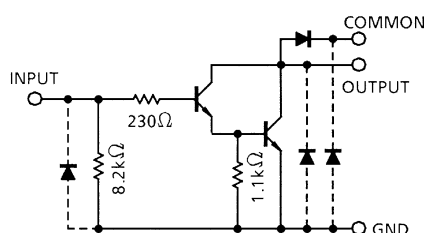#### TD62074P / AP
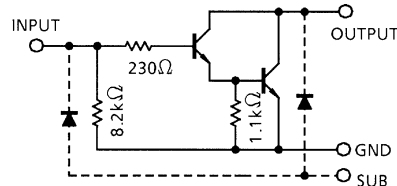
TD62064F / AF

TD62074F / AF

SCHEMATICS (EACH DRIVER)

TD62064P / AP / F / AF

TD62074P / AP / F / AF

Note: The input and output parasitic diodes cannot be used as clamp diodes.

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Output Sustaining Voltage	P, F	$V_{CE (SUS)}$	−0.5~35	V
	AP, AF		−0.5~50	
Output Current		I_{OUT}	1.5	A / ch
Input Current		I_{IN}	50	mA
Input Voltage		V_{IN}	−0.5~17	V
Clamp Diode Reverse Voltage	P, F	V_R (Note 1)	35	V
	AP, AF		50	
Clamp Diode Forward Current		I_F (Note 1)	1.5	A / ch
Isolated Voltage	P, F	V_{SUB} (Note 2)	35	V
	AP, AF		50	
Power Dissipation	P, AP	P_D	1.47 / 2.7 (Note 3)	W
	F, AF		0.9 / 1.4 (Note 4)	
Operating Temperature		T_{opr}	−40~85	°C
Storage Temperature		T_{stg}	−55~150	°C

Note 1: TD62064P / AP / F / AF
Note 2: TD62074P / AP / F / AF
Note 3: On Glass Epoxy PCB (50 × 50 × 1.6 mm Cu 50%)
Note 4: On Glass Epoxy PCB (60 × 30 × 1.6 mm Cu 30%)

RECOMMENDED OPERATING CONDITIONS (Ta = −40~85°C)

| CHARACTERISTIC		SYMBOL	TEST CONDITION		MIN	TYP.	MAX	UNIT
Output Sustaining Voltage	P, F	$V_{CE (SUS)}$			0	—	35	V
	AP, AF				0	—	50	
Output Current	P, AP (Note 1)	I_{OUT}	DC1 Circuit, Ta = 25°C		0	—	1250	mA / ch
			T_{pw} = 25 ms 4 Circuits T_j = 120°C Ta = 85°C	Duty = 10 %	0	—	1250	
				Duty = 50 %	0	—	390	
	F, AF (Note 2)			Duty = 10 %	0	—	907	
				Duty = 50 %	0	—	172	
Input Voltage		V_{IN}			0	—	8	V
	(Output On)	$V_{IN (ON)}$	I_{OUT} = 1.25 A		2.5	—	8	V
	(Output Off)	$V_{IN (OFF)}$			0	—	0.4	V
Input Current		I_{IN}			0	—	20	mA
Clamp Diode Reverse Voltage	P, F	V_R	TD62064P / AP / F / AF		0	—	35	V
	AP, AF				0	—	50	
Clamp Diode Forward Current		I_F			—	—	1.25	A
Isolation Voltage	P, F	V_{SUB}	TD62074P / AP / F / AF		—	—	35	V
	AP, AF				—	—	50	
Power Dissipation	P, AP	P_D	Ta = 85°C (Note 1)		—	—	1.4	W
	F, AF		Ta = 85°C (Note 2)		—	—	0.7	

Note 1: On Glass Epoxy PCB (50 × 50 × 1.6 mm Cu 50%)
Note 2: On Glass Epoxy PCB (60 × 30 × 1.6 mm Cu 30%)

## ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CIR‑CUIT	TEST CONDITION		MIN	TYP.	MAX	UNIT
Output Leakage Current	AP, AF	I_{CEX}	1	V_{CE} = 50 V, Ta = 25°C		—	—	50	µA
				V_{CE} = 50 V, Ta = 85°C		—	—	500	
	P, F			V_{CE} = 35 V, Ta = 25°C		—	—	50	
				V_{CE} = 35 V, Ta = 85°C		—	—	500	
Collector−Emitter Saturation Voltage		$V_{CE (sat)}$	2	I_{OUT} = 1.25 A, I_{IN} = 2 mA		—	—	1.6	V
				I_{OUT} = 0.75 A, I_{IN} = 935 µA		—	—	1.25	
DC Current Transfer Ratio		h_{FE}	2	V_{CE} = 2 V	I_{OUT} = 1.0 A	—	800	—	
					I_{OUT} = 0.25 A	—	1500	—	
Input Voltage (Output On)		$V_{IN (ON)}$	3	I_{OUT} = 1.25 A, I_{IN} = 2 mA		—	—	2.4	V
Clamp Diode Leakage Current	AP, AF	I_R	4	V_R = 50 V, Ta = 25°C		—	—	50	µA
				V_R = 50 V, Ta = 85°C		—	—	100	
	F			V_R = 35 V, Ta = 25°C		—	—	50	
				V_R = 35 V, Ta = 85°C		—	—	100	
Clamp Diode Forward Voltage		V_F	5	I_F = 1.25 A		—	—	2	V
Input Capacitance		C_{IN}	6	V_{IN} = 0 V, f = 1MHz		—	15	—	pF
Turn−On Delay	P, F	t_{ON}	7	V_{OUT} = 35 V, R_L = 29 Ω		—	0.1	—	µs
	AP, AF			V_{OUT} = 50 V, R_L = 42 Ω					
Turn−Off Delay	P, F	t_{OFF}		C_L = 15 pF	V_{OUT} = 35 V, R_L = 29 Ω	—	1.0	—	
	AP, AF				V_{OUT} = 50 V, R_L = 42 Ω				

TEST CIRCUIT

1. I_{CEX}
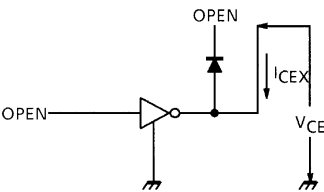
2. $V_{CE (sat)}$, h_{FE}
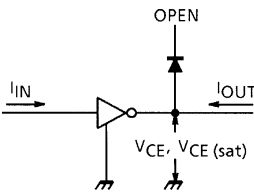
3. $V_{IN (ON)}$
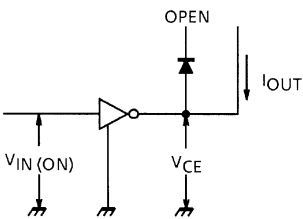
4. I_R
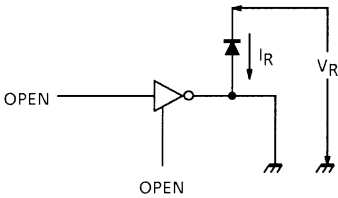
5. V_F
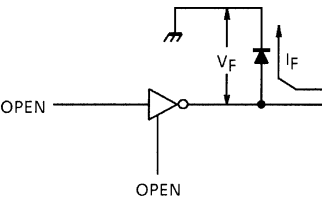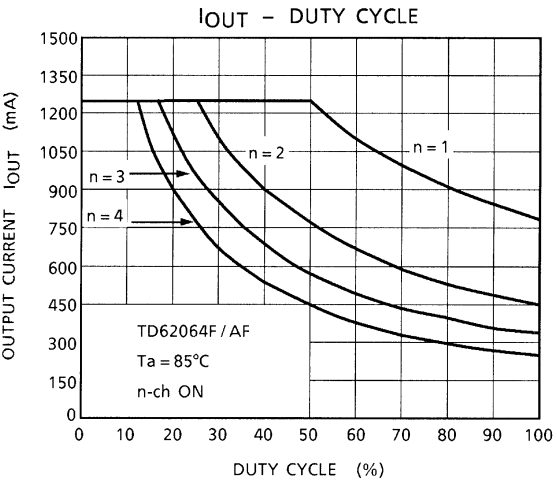

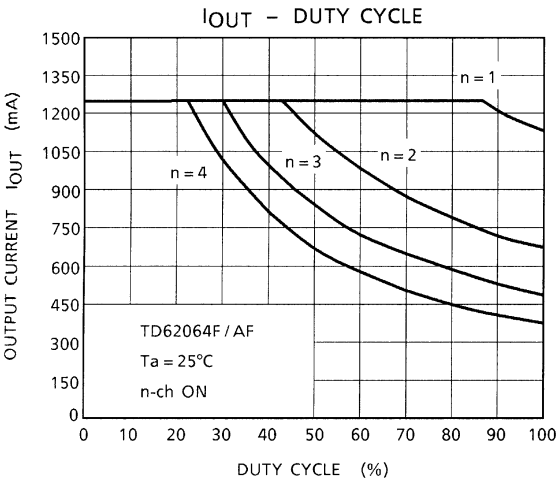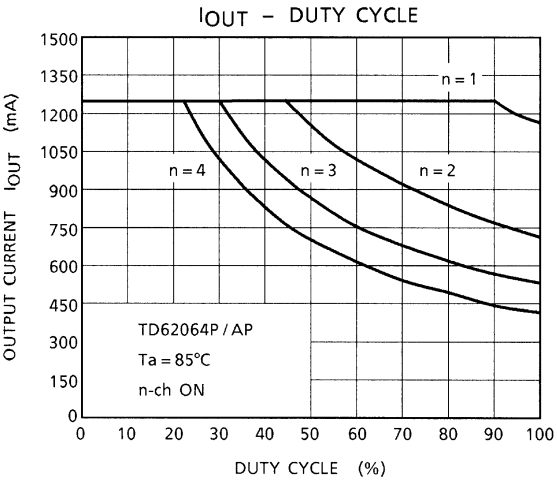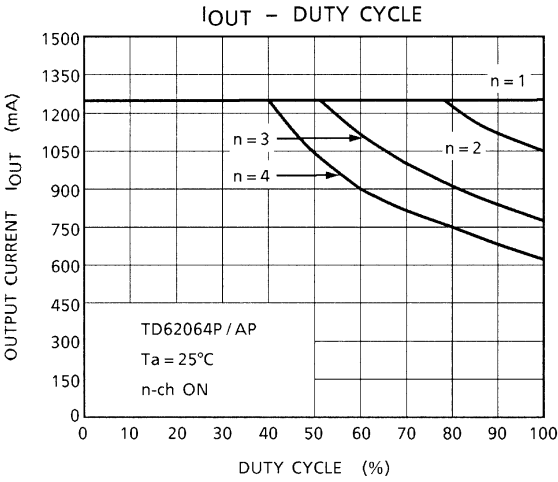
6. C_{IN}
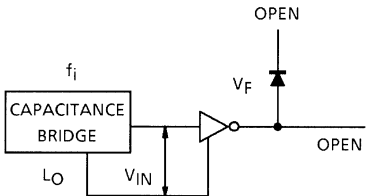
7. t_{ON}, t_{OFF}
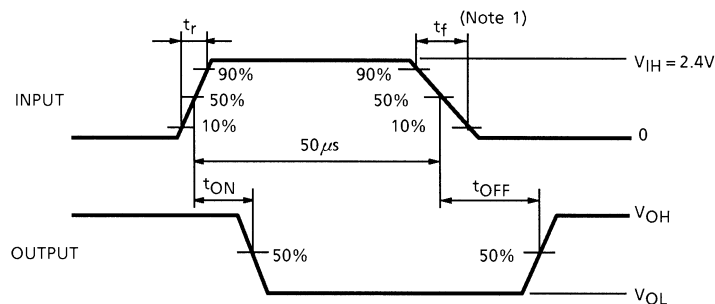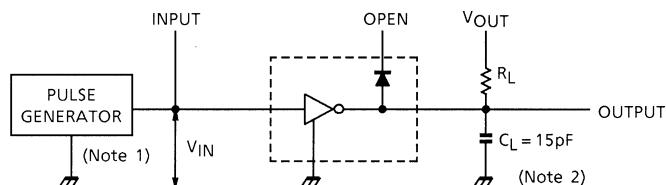
Note 1: Pulse Width 50 μs, Duty Cycle 10%
        Output Impedance 50 Ω, t_r ≤ 5ns, t_f ≤ 10ns
Note 2: C_L includes probe   and jig capacitance

PRECAUTIONS for USING

(1)   This IC does not include built-in protection circuits for excess current or overvoltage.
        If this IC is subjected to excess current or overvoltage, it may be destroyed.
        Hence, the utmost care must be taken when systems which incorporate this IC are designed.
        Utmost care is necessary in the design of the output line, COMMON and GND line since IC may be destroyed
        due to short−circuit between outputs, air contamination fault, or fault by improper grounding.

(2)   When using TD62064P/AP/F/AF to drive an inductive load (such as a motor, solenoid, or relay), Toshiba
        recommend you use diodes (pins 1 and 8) to absorb the counter electromotive force generated when driving an
        inductive load.
        When using TD62074P/AP/F/AF to drive an inductive load (such as a motor, solenoid, or relay), Toshiba
        recommend you connect diodes externally to absorb the counter electromotive force generated when driving
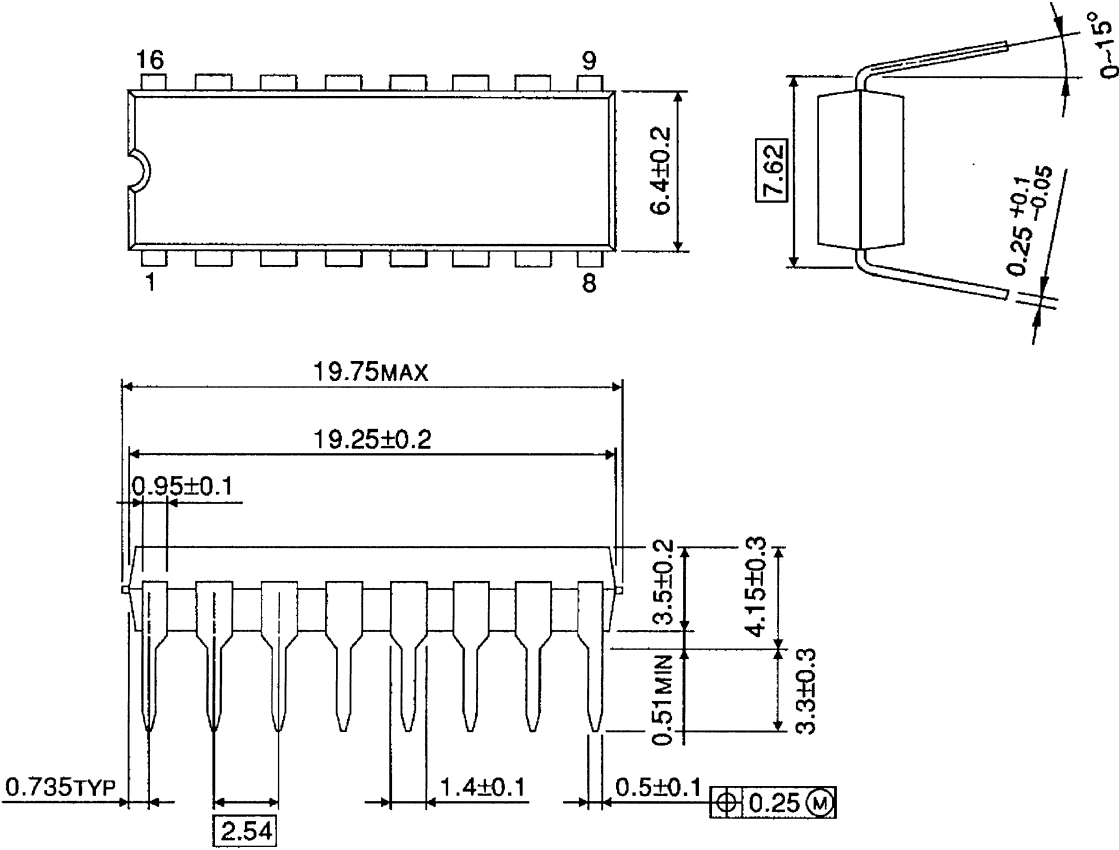   an inductive load.

$I_{OUT} - V_{CE(sat)}$

TD62064P
TD62074P
Ta = 25°C
2mA
1mA
500μA
I_{IN} = 300μA

OUTPUT CURRENT I_{OUT} (A)
COLLECTOR-EMITTER SATURATION VOLTAGE $V_{CE(sat)}$ (V)

$I_{OUT} - V_{CE(sat)}$

TD62064AP
TD62074AP
Typ.
25°C Max.

OUTPUT CURRENT I_{OUT} (A)
COLLECTOR-EMITTER SATURATION VOLTAGE $V_{CE(sat)}$ (V)

$I_{IN} - V_{IN}$

TD62064AP/F
TD62074AP/F
Max.   Typ.   Min.

INPUT CURRENT I_{IN} (mA)
INPUT VOLTAGE V_{IN} (V)

$I_{IN} - V_{IN}$

TD62064P
TD62074P
Ta = 25°C
I_{OUT} = 100mA
500mA
1A

INPUT CURRENT I_{IN} (mA)
INPUT VOLTAGE V_{IN} (V)

$I_{OUT} - I_{IN}$

V_{CE} = 2V
Ta = 75°C   25   −30

OUTPUT CURRENT I_{OUT} (mA)
INPUT CURRENT I_{IN} (μA)

$P_D - T_a$

① Dip-16 pin On Grass Epoxy
   (50×50×1.6mm Cu 50%)
② Dip-16 pin Free Air
③ PFP-16 pin On Grass Epoxy
   (60×30×1.6mm Cu 30%)
④ PFP-16 pin Free Air

POWER DISSIPATION P_D (W)
AMBIENT TEMPERATURE Ta (°C)

2001-06-04

I_{OUT} – DUTY CYCLE

TD62064P / AP
Ta = 25°C
n-ch ON

I_{OUT} – DUTY CYCLE

TD62064P / AP
Ta = 85°C
n-ch ON

I_{OUT} – DUTY CYCLE

TD62064F / AF
Ta = 25°C
n-ch ON

I_{OUT} – DUTY CYCLE

TD62064F / AF
Ta = 85°C
n-ch ON

2001-06-04

PACKAGE DIMENSIONS

DIP16−P−300−2.54A   Unit : mm

Weight: 1.11 g (Typ.)

PACKAGE DIMENSIONS

HSOP16-P-300-1.00

Unit : mm
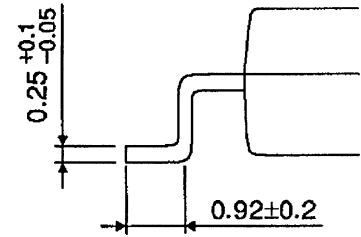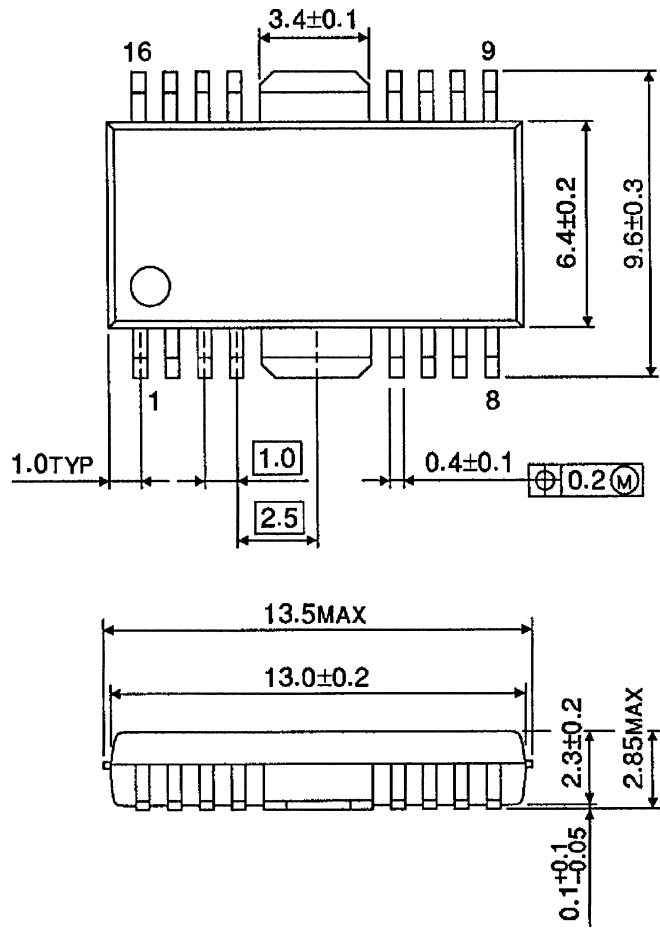
Weight: 0.50 g (Typ.)

RESTRICTIONS ON PRODUCT USE